



EV444356600

1 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

2 Application Serial No. ....09/961,114  
3 Filing Date .....09/20/2001  
4 Inventorship .....Perino et al.  
5 Applicant.....Microsoft Corporation  
6 Group Art Unit .....2833  
7 Examiner .....Figueroa, Felix O  
8 Attorney's Docket No. ....RB1-035USC3  
9 Title: Chip Socket Assembly and Chip File Assembly for Semiconductor Chips  
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**RESPONSE TO OFFICE ACTION DATED JANUARY 20, 2004**

10 To: Commissioner of Patents and Trademarks  
11 Alexandria VA 22313-1450  
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